

FH037N10TL4

N-Channel Enhancement Mode Power MOSFET

◆ General Description

This N channel SGT MOSFET has been designed to very low on-state resistance (RDSON) and yet maintain superior switching performance, especially for high efficiency power management applications.

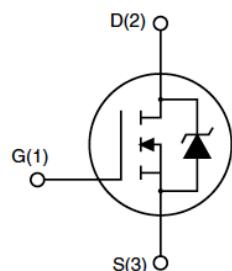
◆ Applications

- Motor drivers
- Power switching application
- Load switch
- Isolated DC/DC Converters In Telecom and Industrial

◆ Product Summary

| Parameter | Typ. | Unit |
|---|------|----------|
| BV _{DSS} | 100 | V (Min) |
| V _{GS(th)} | 3.0 | V(Typ) |
| I _D (@ V _{GS} = 10V) | 120 | A |
| R _{DS(ON)} (@ V _{GS} = 10V) | 3.6 | mΩ (Typ) |

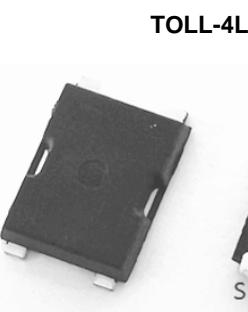
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation



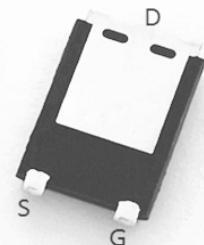
Schematic diagram



Marking and pin assignment



Top view



Bottom View

Absolute Maximum Ratings (TC=25°C unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|---------------------------------------|--|------------|-------|
| V _{DS} | Drain-Source Voltage | 100 | V |
| V _{GS} | Gate-Source Voltage | ±20 | V |
| I _D @T _c =25°C | Continuous Drain Current, V _{GS} =10V | 120 | A |
| I _D @T _c =100°C | Continuous Drain Current, V _{GS} =10V | 75 | A |
| I _{DM} | Pulsed Drain Current ¹ | 480 | A |
| EAS | Single Pulse Avalanche Energy ⁴ | 530 | mJ |
| P _D @T _c =25°C | Total Power Dissipation | 126 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| T _j | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Characteristic

| Symbol | Parameter | Typ | Max | Units |
|------------------|-------------------------------------|-----|------|-------|
| R _{θJA} | Thermal Resistance Junction-Ambient | | 61.3 | °C/W |
| R _{θJC} | Thermal Resistance Junction-Case | -- | 0.65 | °C/W |

Electrical Characteristics (TC=25°C unless otherwise noted)

| Symbol | Parameter | Values | | | Unit | Note / Test Condition |
|-----------------|--|--------|------|------|------|-----------------------------------|
| | | Min. | Typ. | Max. | | |
| BVDSS | Drain-Source Breakdown Voltage | 100 | -- | -- | V | VGS=0V, ID=250uA |
| RDS(ON) | Static Drain-Source On-Resistance | -- | 3.6 | 4.5 | mΩ | VGS=10V, ID=30A |
| VGS(th) | Gate Threshold Voltage | 2 | 3 | 4 | V | VGS=VDS, ID=250uA |
| IDSS | Drain-Source Leakage Current | -- | -- | 1 | uA | VDS=100V, VGS=0V, TJ=25°C |
| | | -- | -- | 10 | uA | VDS=100V, VGS=0V, TJ=125°C |
| IGSS | Gate-Source Leakage Current | -- | -- | ±100 | nA | VGS=±20V, VDS=0V |
| gfs | Forward Transconductance | -- | 50 | -- | S | VDS=5V, ID=30A |
| Rg | Gate Resistance | -- | 0.64 | -- | Ω | VDS=0V, VGS=0V, f=1MHz |
| Qg | Total Gate Charge (10V) ^{2,3} | -- | 90 | -- | nC | VDS=50V, VGS=10V, ID=20A |
| Qgs | Gate-Source Charge ^{2,3} | -- | 28 | -- | | |
| Qgd | Gate-Drain Charge ^{2,3} | -- | 19 | -- | | |
| Td(on) | Turn-On Delay Time ^{2,3} | -- | 28 | -- | ns | VDD=50V, VGS=10V, RG=3Ω ID=30A |
| Tr | Rise Time ^{2,3} | -- | 32 | -- | | |
| Td(off) | Turn-Off Delay Time ^{2,3} | -- | 48 | -- | | |
| Tf | Fall Time ^{2,3} | -- | 27 | -- | | |
| Ciss | Input Capacitance | -- | 5385 | -- | pF | VDS=50V, VGS=0V, f=1MHz |
| Coss | Output Capacitance | -- | 1530 | -- | | |
| Crss | Reverse Transfer Capacitance | -- | 136 | -- | | |
| Trr | Body Diode Reverse Recovery Time | -- | 80 | -- | ns | IF=30A, di/dt=100A/us |
| Qrr | Body Diode Reverse Recovery Charge | -- | 190 | -- | | |
| V _{SD} | Diode Forward Voltage | | -- | 1 | V | VGS=0V, IS=1A, TJ=25 °C |

Note:

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.
4. The EAS data shows Max. rating. The test condition is VDD=50V, VGS=10V, L=0.5mH.

Typical Performance Characteristics

Fig1 Output Characteristics

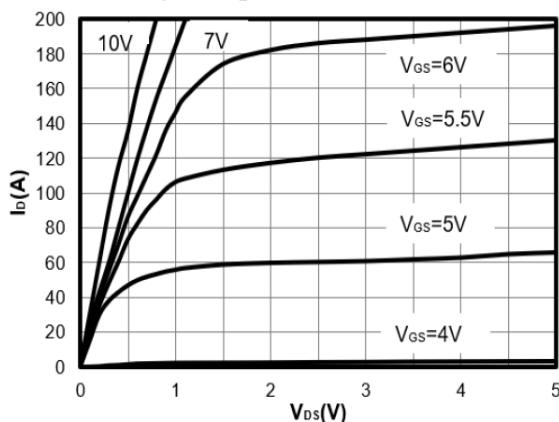


Fig2 Transfer Characteristics

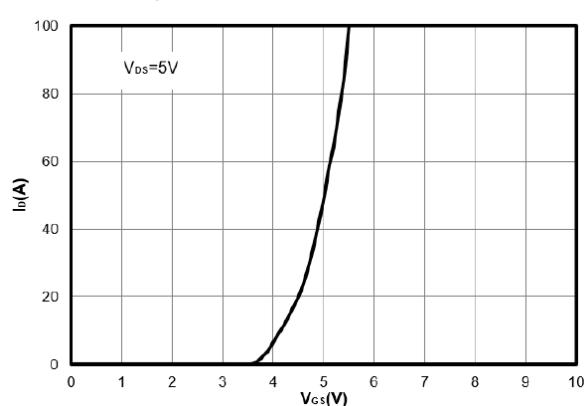


Fig3 Rdson VS Drain current

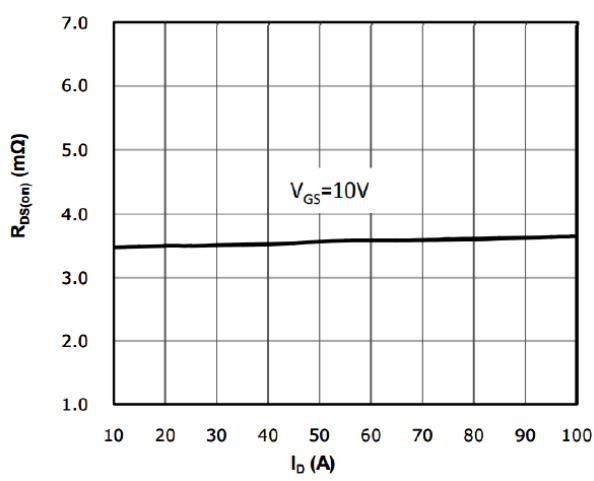


Fig4 Capacitance Characteristics

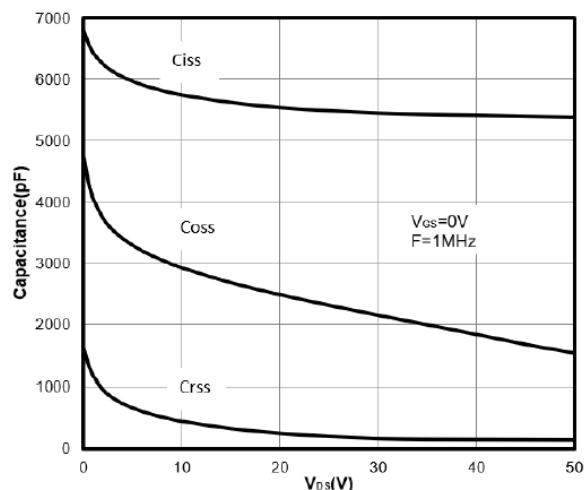


Fig5 Gate Charge Characteristics

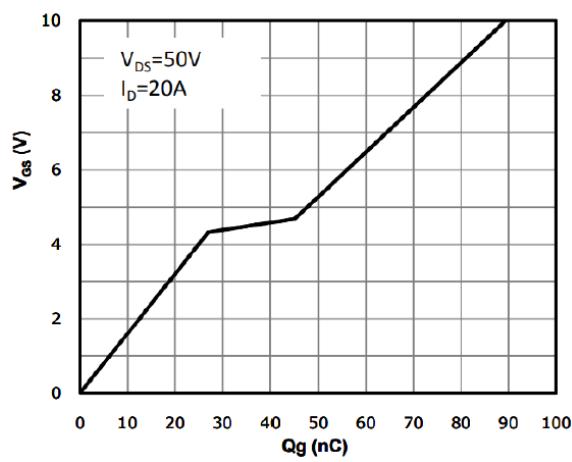


Fig.6 Safe Operating Area

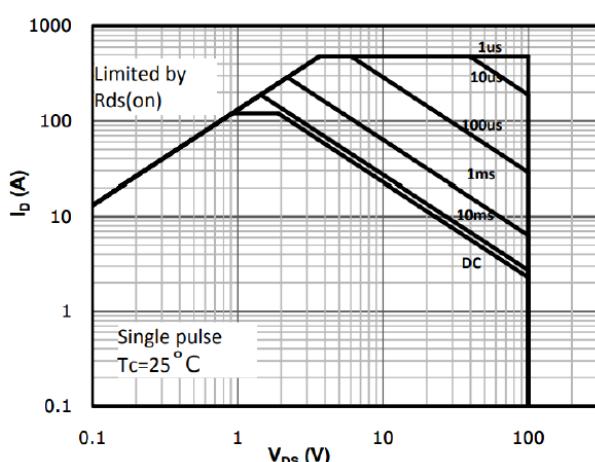
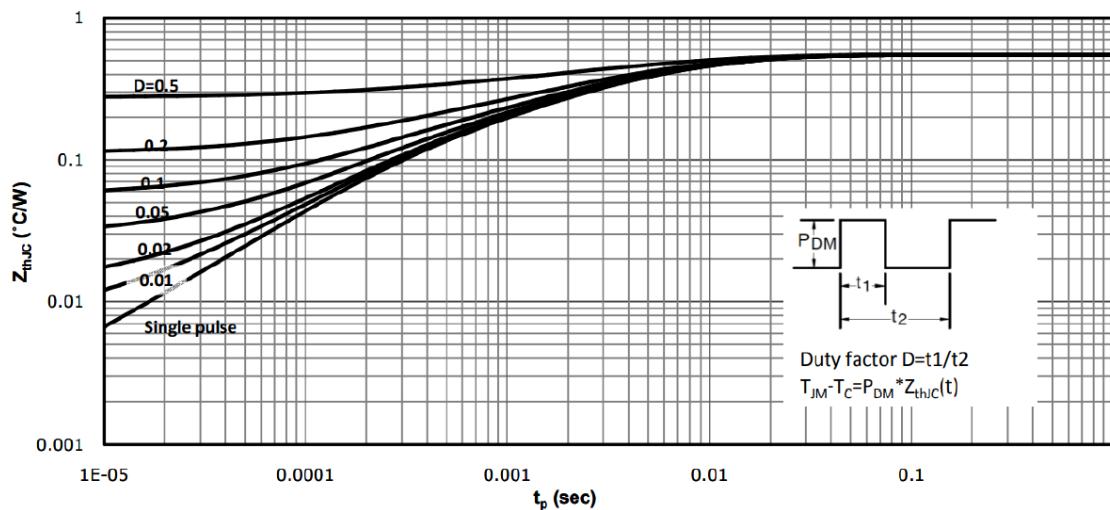
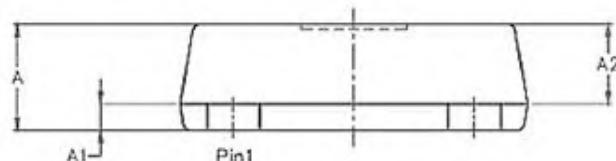
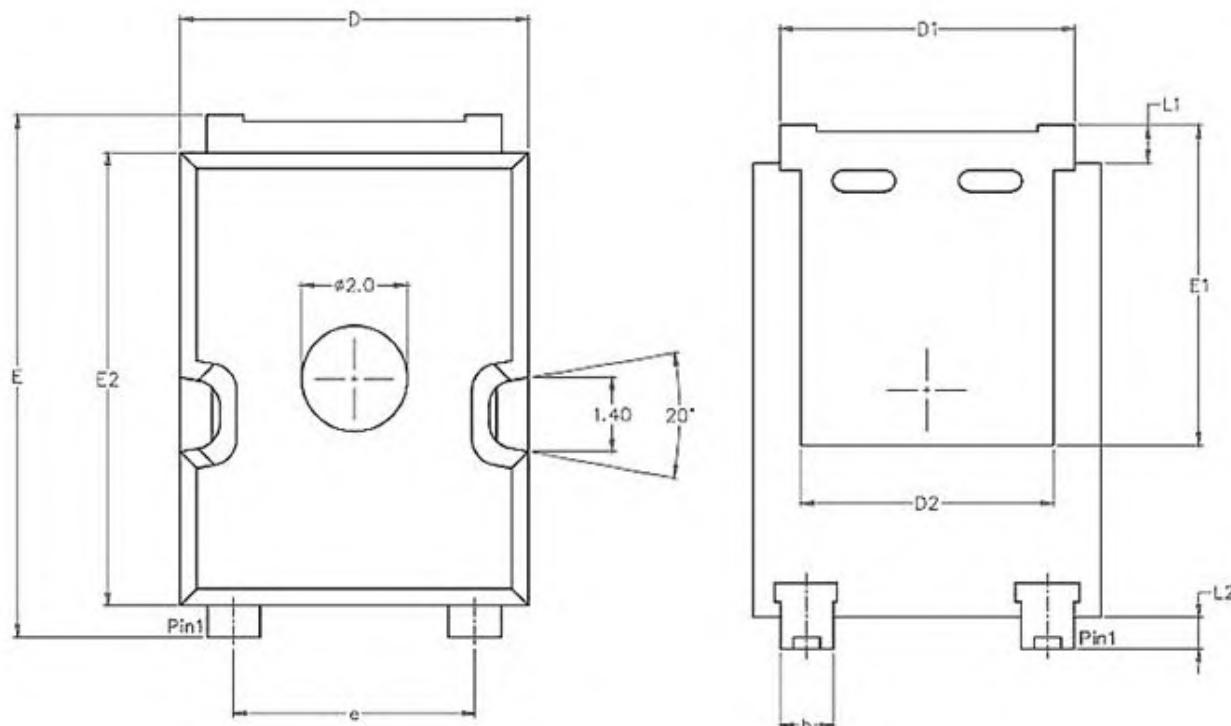


Fig.7 Max. Transient Thermal Impedance

Package Information : TOLL-4L

| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN | NOM | MAX |
| A | 1.95 | 2.00 | 2.05 |
| A1 | 0.45 | 0.50 | 0.55 |
| A2 | 1.45 | 1.50 | 1.55 |
| b | 0.95 | 1.00 | 1.05 |
| D | 6.55 | 6.60 | 6.65 |
| E | 9.85 | 9.90 | 9.95 |
| D1 | 5.55 | 5.60 | 5.65 |
| D2 | 4.75 | 4.80 | 4.85 |
| E1 | 6.00 | 6.05 | 6.10 |
| E2 | 8.55 | 8.60 | 8.65 |
| e | 4.54 | 4.57 | 4.60 |
| L1 | 0.65 | 0.70 | 0.75 |
| L2 | 0.55 | 0.60 | 0.65 |